



LEOPARD IMAGING INC

Rev. 1.0

# LI-IMX385-MIPI-M12

## Data Sheet

### Key Features

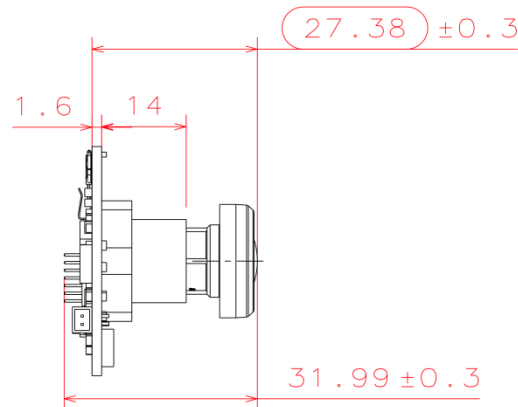
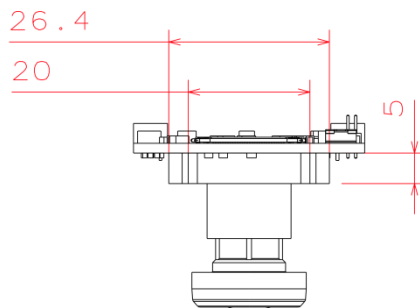
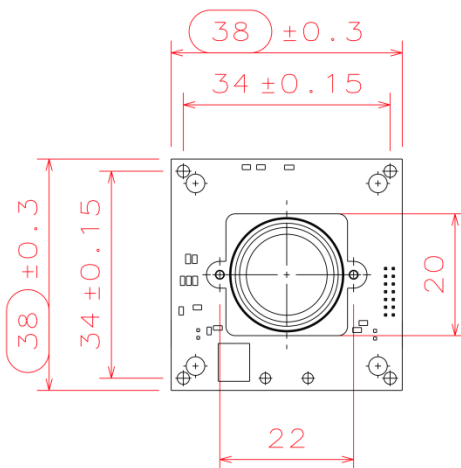
- Sony Diagonal 8.35mm Type 1/2 CMOS Image Sensor IMX385LQR
- Active pixels: 1937H x 1097V
- Pixel size: 3.75  $\mu\text{m}$  x 3.75  $\mu\text{m}$
- Color sensor
- Interface: MIPI output
- Support M12 lens
- Module Size: 38mm x 38mm
- Weight: 12 g
- Part#: **LI-IMX385-MIPI-M12**



### Lens Spec

- Model: SYD1201A
- Focal length: 3.7 mm
- Aperture, F/#: 2.8 +/- 5%
- Built in 650nm IR cut filter
- FOV (D/H/V): 102 °/ 92 °/60 °
- TV Distortion: -1.0 %
- Mount: M12 x P0.5

### Dimensions



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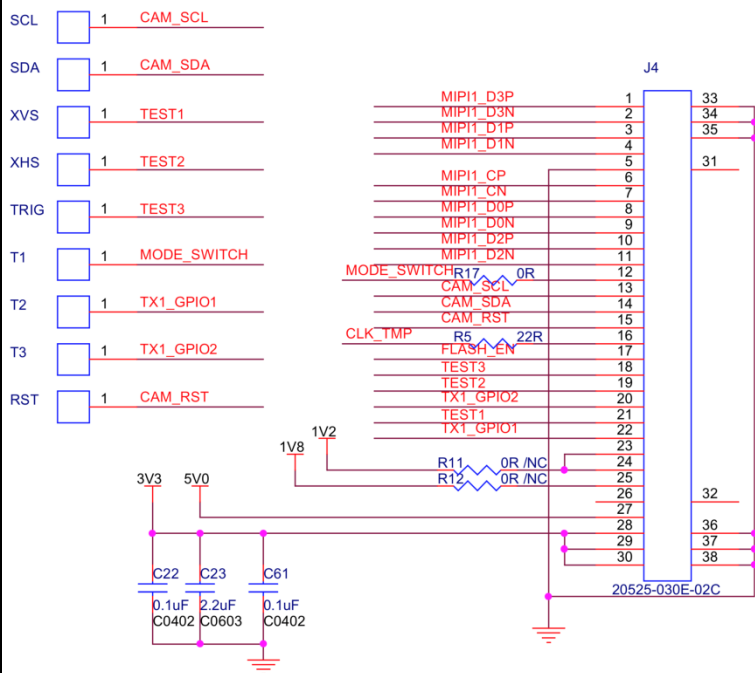
48820 Kato Rd, Suite 100B, Fremont, CA 94538, USA  
Phone: +1-408-263-0988  
Fax: +1-408-217-1960  
Email: [sales@leopardimaging.com](mailto:sales@leopardimaging.com)  
Website: [www.leopardimaging.com](http://www.leopardimaging.com)

# Interfaces

## Interfaces

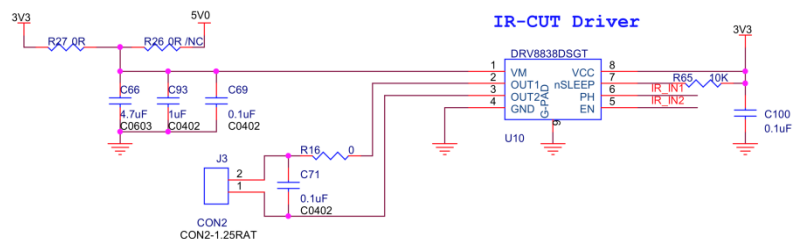
### Interface J4:

- Part#: 20525-030E-02C
- Number of Positions: 30
- Pitch: 0.4mm
- Mating I-PEX cable: FAW-1233-03 (300mm)



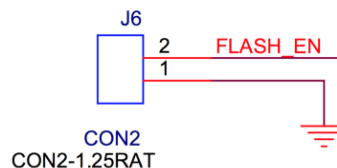
### Interface J3:

- Part#: 1734829-2
- Number of Positions: 2
- Pitch: 1.25mm



### Interface J6:

- Part#: 1734829-2
- Number of Positions: 2
- Pitch: 1.25mm



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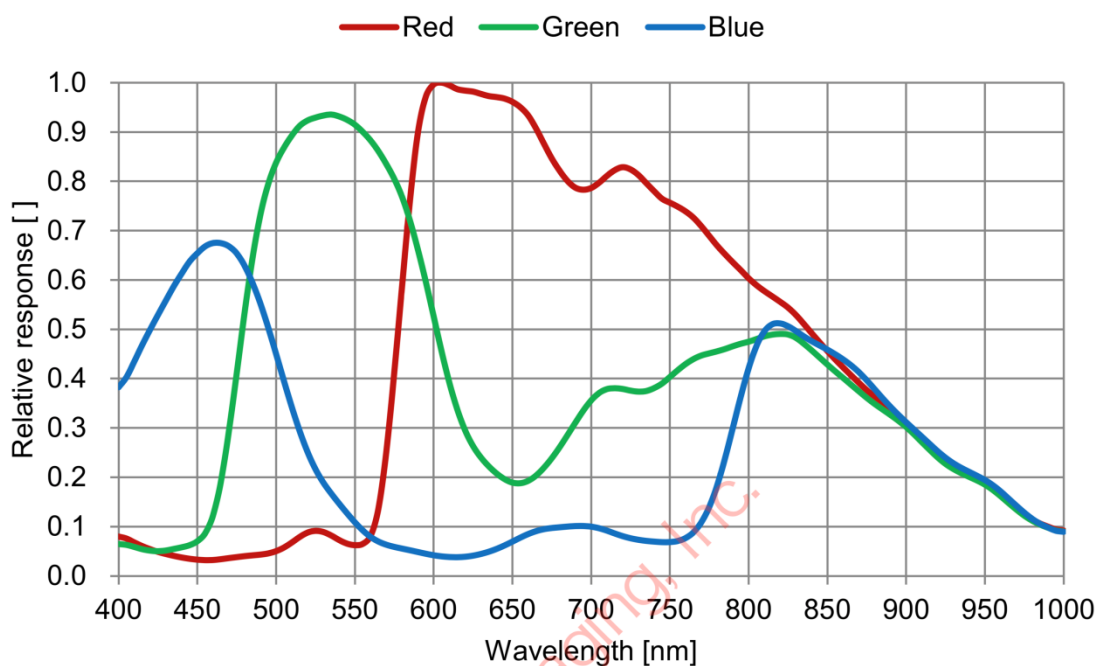
## Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remarks
Supply voltage (analog 3.3 V)	AV <sub>DD</sub>	-0.3	4.0	V	—
Supply voltage (interface 1.8 V)	OV <sub>DD</sub>	-0.3	3.3	V	—
Supply voltage (digital 1.2 V)	DV <sub>DD</sub>	-0.3	2.0	V	—
Input voltage	VI	-0.3	OV <sub>DD</sub> + 0.3	V	Not exceed 3.3 V
Output voltage	VO	-0.3	OV <sub>DD</sub> + 0.3	V	Not exceed 3.3 V
Operating temperature	T <sub>opr</sub>	-30	85	°C	—
Storage temperature	T <sub>stg</sub>	-40	85	°C	—

## Recommended Operating Conditions

Item	Symbol	Min.	Typ.	Max.	Unit
Supply voltage (analog 3.3 V)	AV <sub>DD</sub>	3.15	3.30	3.45	V
Supply voltage (Interface 1.8 V)	OV <sub>DD</sub>	1.70	1.80	1.90	V
Supply voltage (digital 1.2 V)	DV <sub>DD</sub>	1.10	1.20	1.30	V

## Spectral Sensitivity Characteristics



## DC Characteristics

Item		Pins	Symbol	Condition	Min.	Typ.	Max.	Unit
Supply voltage	analog	VDDHx	AV <sub>DD</sub>	—	3.15	3.30	3.45	V
	Interface	VDDMx	OV <sub>DD</sub>	—	1.70	1.80	1.90	V
	digital	VDDLx	DV <sub>DD</sub>	—	1.10	1.20	1.30	V
Digital input voltage		XHS XVS XCLR INCK XMASTER OMODE SCK SDI XCE XTRIG	VIH	XVS / XHS Slave Mode	0.8OV <sub>DD</sub>	—	—	V
			VIL		—	—	0.2OV <sub>DD</sub>	V
Digital output voltage		DLOP [A:H] DLOM [A:H] DLCKP DLCKM	VCM	Low voltage LVDS	—	OV <sub>DD</sub> /2	—	V
			VOD	Low voltage LVDS (Termination resistance: 100 Ω)	100	150	220	mV
		XHS XVS SDO TOUT	VOH	XVS / XHS Master Mode	OV <sub>DD</sub> -0.4	—	—	V
			VOL		—	—	0.4	V

## Power Consumption

Item	pin	Symbol	Typ.		Max.		Unit
			Standard luminous intensity	Saturated luminous intensity	Standard luminous intensity	Saturated luminous intensity	
Operating current Low voltage LVDS serial 4 ch 12 bit 60 frame / s All pixel scan mode	VDDH	IAV <sub>DD</sub>	85	85	140	140	mA
	VDDM	IOV <sub>DD</sub>	15	15	25	25	mA
	VDDL	IDV <sub>DD</sub>	80	100	135	170	mA
Operating current MIPI CSI-2 / 4 lane 12 bit 60 frame / s All pixel scan mode	VDDH	IAV <sub>DD</sub>	85	85	140	140	mA
	VDDM	IOV <sub>DD</sub>	1	1	5	5	mA
	VDDL	IDV <sub>DD</sub>	92	112	155	185	mA
Standby current	VDDH	IAV <sub>DD_STB</sub>	—		0.1		mA
	VDDM	IOV <sub>DD_STB</sub>	—		0.1		mA
	VDDL	IDV <sub>DD_STB</sub>	—		14		mA

Operating current: (Typ.) Supply voltage 3.3 V / 1.8 V / 1.2 V, T<sub>j</sub> = 25 °C  
(Max.) Supply voltage 3.45 V / 1.9 V / 1.3 V, T<sub>j</sub> = 60 °C, worst state of internal circuit  
operating current consumption,

Standby: (Max.) Supply voltage 3.45 V / 1.9 V / 1.3 V, T<sub>j</sub> = 60 °C, INCK: 0 V,  
The device in the light-obstructed state.

Standard luminous intensity: luminous intensity at 1/3 of the sensor saturated.

Saturated luminous intensity: luminous intensity when the sensor is saturated.

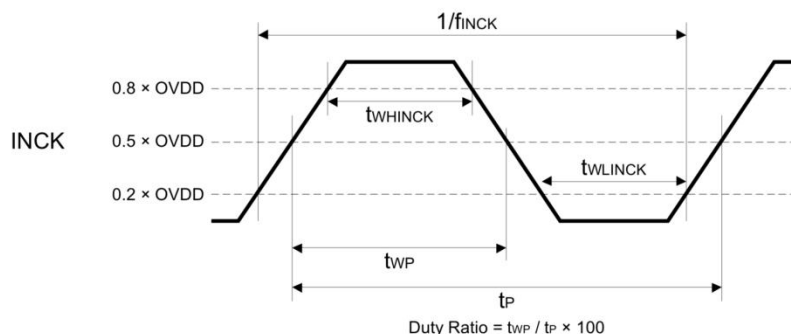


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## AC Specification

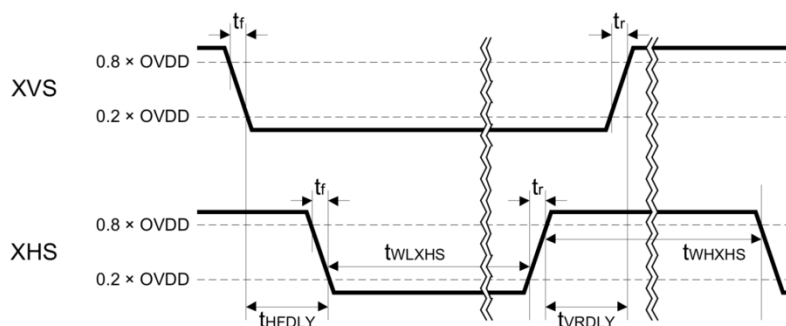
### Master Clock Waveform (INCK)



Item	Symbol	Min.	Typ.	Max.	Unit	Remarks
INCK clock frequency	$f_{INCK}$	$f_{INCK} \times 0.96$	$f_{INCK}$	$f_{INCK} \times 1.02$	MHz	$f_{INCK} = 37.125 \text{ MHz}, 74.25 \text{ MHz}$
INCK Low level pulse width	$t_{WLINCK}$	4	—	—	ns	$f_{INCK} = 37.125 \text{ MHz}, 74.25 \text{ MHz}$
INCK High level pulse width	$t_{WHINCK}$	4	—	—	ns	$f_{INCK} = 37.125 \text{ MHz}, 74.25 \text{ MHz}$
INCK clock duty	—	45.0	50.0	55.0	%	Define with $0.5 \times OV_{DD}$

\*The INCK fluctuation affects the frame rate.

### XVS / XHS Input Characteristics In Slave Mode (DMODE pin = High)



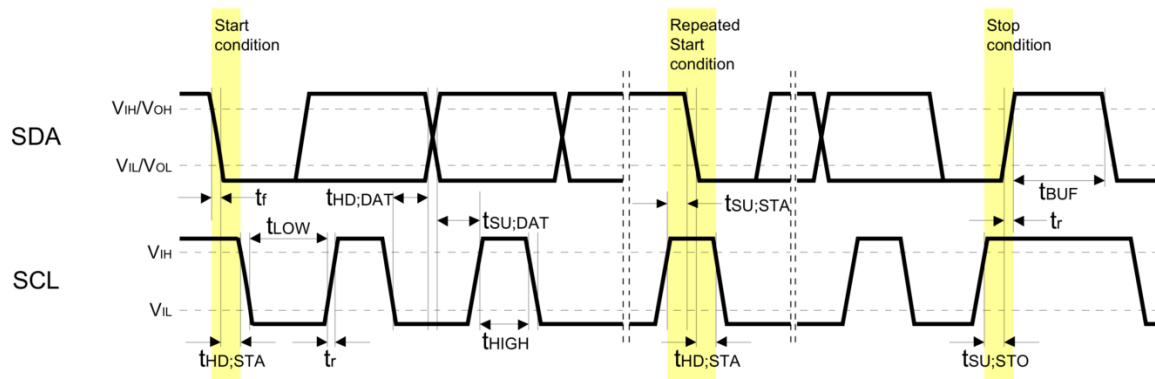
Item	Symbol	Min.	Typ.	Max.	Unit	Remarks
XHS Low level pulse width	$t_{WLXHS}$	$4 / f_{INCK}$	—	—	ns	—
XHS High level pulse width	$t_{WHXHS}$	$4 / f_{INCK}$	—	—	ns	—
XVS - XHS fall width	$t_{HFDLY}$	$1 / f_{INCK}$	—	—	ns	—
XHS - XVS rise width	$t_{VRDLY}$	$1 / f_{INCK}$	—	—	ns	—
XVS, XHS rise time	$t_r$	—	—	5	ns	20 % to 80 %
XVS, XHS fall time	$t_f$	—	—	5	ns	80 % to 20 %



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## I<sup>2</sup>C Communication



## I<sup>2</sup>C Specification

Item	Symbol	Min.	Typ.	Max.	Unit	条件
Low level input voltage	VIL	-0.3	—	$0.3 \times OVDD$	V	—
High level input voltage	VIH	$0.7 \times OVDD$	—	1.9	V	—
Low level input voltage	VOL	0	—	$0.2 \times OVDD$	V	$OVDD < 2\text{ V}$ , Sink 3 mA
High level input voltage	VOH	$0.8 \times OVDD$	—	—	V	—
Output fall time	tof	—	—	250	ns	Load 10 pF – 400 pF, $0.7 \times OVDD - 0.3 \times OVDD$
Input current	Ii	-10	—	10	μA	$0.1 \times OVDD - 0.9 \times OVDD$
Capacitance for SCK (SCL) /SDI (SDA)	Ci	—	—	10	pF	—

## I<sup>2</sup>C AC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit
SCL clock frequency	$f_{SCL}$	0	—	400	kHz
Hold time (Start Condition)	$t_{HD;STA}$	0.6	—	—	μs
Low period of the SCL clock	$t_{LOW}$	1.3	—	—	μs
High period of the SCL clock	$t_{HIGH}$	0.6	—	—	μs
Set-up time (Repeated Start Condition)	$t_{SU;STA}$	0.6	—	—	μs
Data hold time	$t_{HD;DAT}$	0	—	0.9	μs
Data set-up time	$t_{SU;DAT}$	100	—	—	ns
Rise time of both SDA and SCL signals	$t_r$	—	—	300	ns
Fall time of both SDA and SCL signals	$t_f$	—	—	300	ns
Set-up time (Stop Condition)	$t_{SU;STO}$	0.6	—	—	μs
Bus free time between a STOP and START Condition	$t_{BUF}$	1.3	—	—	μs

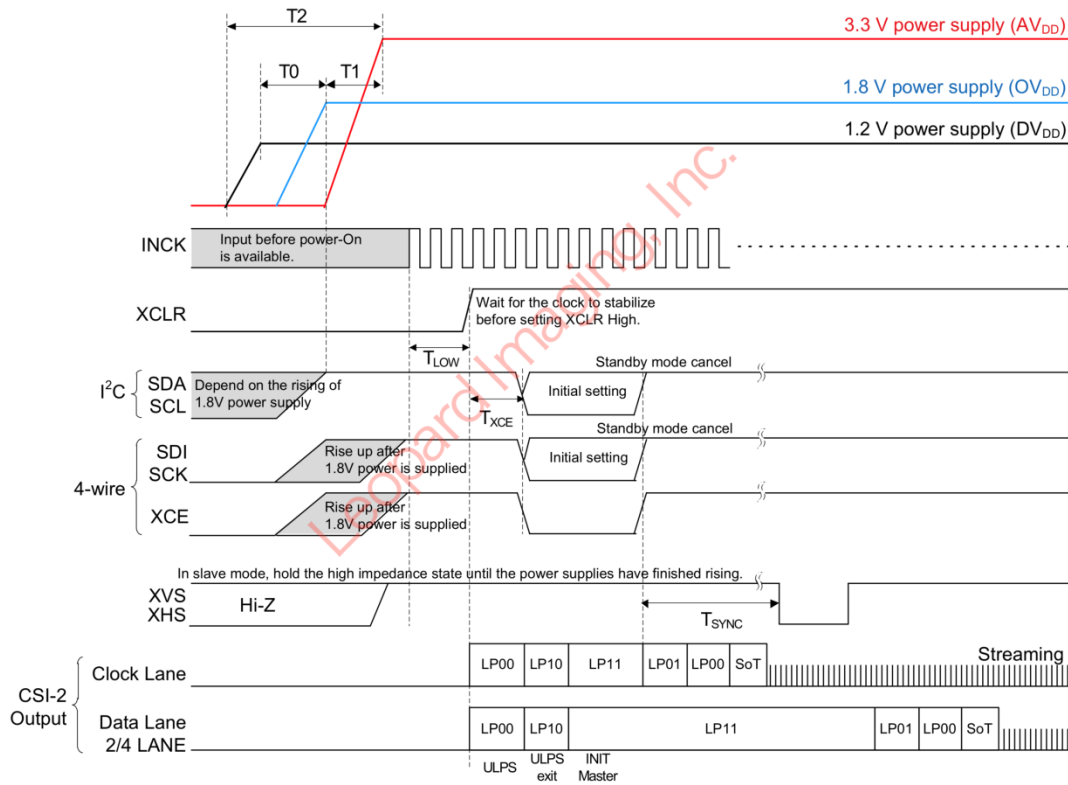


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## Power-on Sequence

1. Turn On the power supplies so that the power supplies rise in order of 1.2 V power supply (DV<sub>DD</sub>) → 1.8 V power supply (OV<sub>DD</sub>) → 3.3 V power supply (AV<sub>DD</sub>). In addition, all power supplies should finish rising within 200 ms.
2. Start master clock (INCK) input after turning On the power supplies.
3. The register values are undefined immediately after power-on, so the system must be cleared. Hold XCLR at Low level for 500 ns or more after all the power supplies have finished rising. (The register values after a system clear are the default values.) In addition, hold XCE to High level during this period. Rise XCE after 1.8 V power supply (OV<sub>DD</sub>).
4. The system clear is applied by setting XCLR to High level. However, the maser clock needs to stabilize before setting the XCLR pin to High level.
5. Make the sensor setting by register communication after the system clear. A period of 20  $\mu$ s or more should be provided after setting XCLR High before inputting the communication enable signal XCE. In I<sup>2</sup>C communication, XCE is fixed to High.



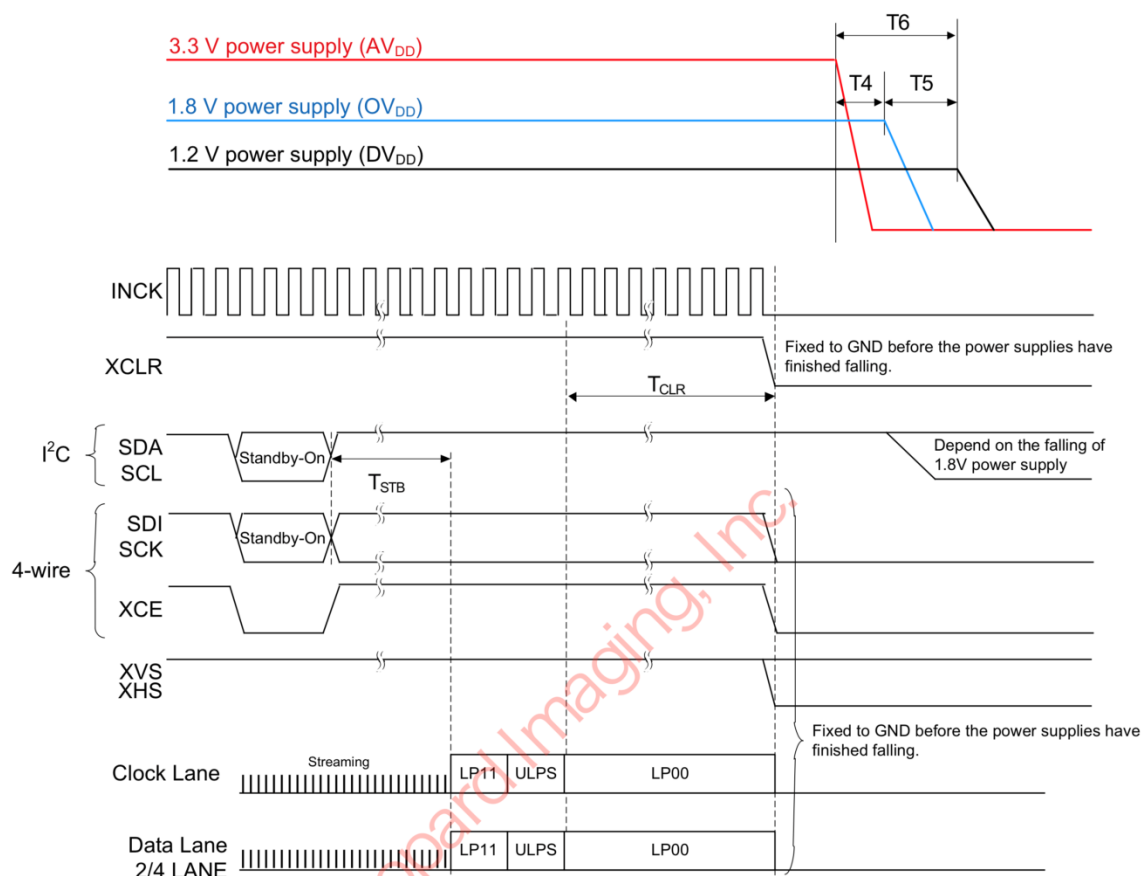
Item	Symbol	Min.	Max.	Unit
1.2 V power supply rising → 1.8 V power supply rising	T <sub>0</sub>	0	—	ns
1.8 V power supply rising → 3.3 V power supply rising	T <sub>1</sub>	0	—	ns
Rising time of all power supply	T <sub>2</sub>	—	200	ms
INCK active → Clear OFF	T <sub>LOW</sub>	500	—	ns
Clear OFF → Communication start	T <sub>XCE</sub>	20	—	$\mu$ s
Standby OFF (communication) → External input XHS,XVS (slave mode only)	T <sub>SYNC</sub>	20	—	ms





## Power-off Sequence

Turn Off the power supplies so that the power supplies fall in order of 3.3 V power supply ( $AV_{DD}$ ) → 1.8 V power supply ( $OV_{DD}$ ) → 1.2 V power supply ( $DV_{DD}$ ). In addition, all power supplies should falling within 200 ms. Set each digital input pin (INCK, XCE, SCK, SDI, XCLR, XMASTER, OMODE, XVS, XHS) to 0 V before the 1.8 V power supply ( $OV_{DD}$ ) falls.



Item	Symbol	Min.	Max.	Unit
Standby ON (communication) → LP11 mode start	$T_{STB}$	Until FE		—
LP00 → XCLR falling	$T_{CLR}$	128	—	cycle
3.3 V power shut down → 1.8 V power shut down	T4	0	—	ns
1.8 V power shut down → 1.2 V power shut down	T5	0	—	ns
Shut down time of all power supply	T6	—	200	ms

